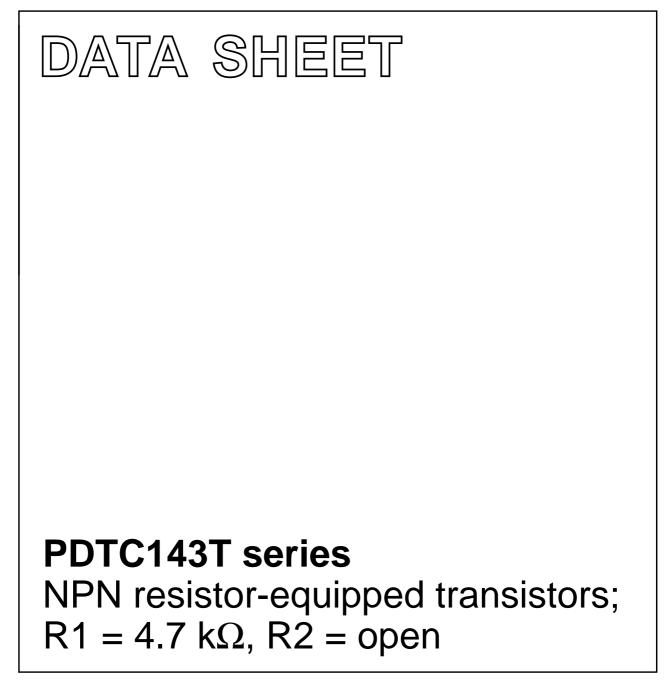
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 2004 Apr 06 2004 Aug 06



PDTC143T series

FEATURES

- Built-in bias resistors
- Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- General purpose switching and amplification
- Inverter and interface circuits
- Circuit applications.

PRODUCT OVERVIEW

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-	50	V
lo	output current (DC)	-	100	mA
R1	bias resistor	4.7	_	kΩ
R2	open	-	-	-

DESCRIPTION

NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

TYPE NUMBER	PACKAGE		MARKING CODE	PNP COMPLEMENT	
	PHILIPS	EIAJ	MARKING CODE		
PDTC143TE	SOT416	SC-75	40	PDTA143TE	
PDTC143TEF	SOT490	SC-89	11	PDTA143TEF	
PDTC143TK	SOT346	SC-59	52	PDTA143TK	
PDTC143TM	SOT883	SC-101	DM	PDTA143TM	
PDTC143TS	SOT54 (TO-92)	SC-43	TC143T	PDTA143TS	
PDTC143TT	SOT23	_	*33 ⁽¹⁾	PDTA143TT	
PDTC143TU	SOT323	SC-70	*52 ⁽¹⁾	PDTA143TU	

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

NPN resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$, R2 = open

PDTC143T series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

	SIMPLIFIED OUTLINE AND SYMBOL		PINNING		
TYPE NUMBER			DESCRIPTION		
PDTC143TS		1	base		
		2	collector		
		3	emitter		
PDTC143TE PDTC143TEF PDTC143TK		1 2 3	base emitter collector		
PDTC143TK PDTC143TT PDTC143TU	Top view MDB270	3	Conector		
PDTC143TM		1	base		
		2	emitter		
	2 1 Bottom view MHC507	3	collector		

PDTC143T series

ORDERING INFORMATION

	PACKAGE				
TYPE NUMBER	NAME	DESCRIPTION	VERSION		
PDTC143TE	-	plastic surface mounted package; 3 leads	SOT416		
PDTC143TEF	-	 plastic surface mounted package; 3 leads 			
PDTC143TK	-	 plastic surface mounted package; 3 leads 			
PDTC143TM	-	- leadless ultra small plastic package; 3 solder lands; body $1.0 \times 0.6 \times 0.5$ mm			
PDTC143TS – plastic single-ended leaded (through hole) package; 3 leads		SOT54			
PDTC143TT	 plastic surface mounted package; 3 leads 		SOT23		
PDTC143TU	_	 plastic surface mounted package; 3 leads 			

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL PARAMETER		CONDITIONS	MIN.	MAX.	UNIT	
V _{CBO}	collector-base voltage	open emitter	_	50	V	
V _{CEO}	collector-emitter voltage	open base	-	50	V	
V _{EBO}	emitter-base voltage	open collector	-	5	V	
lo	output current (DC)		-	100	mA	
I _{CM}	collector current		-	100	mA	
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$				
	SOT54	note 1	_	500	mW	
	SOT23	note 1	_	250	mW	
	SOT346	note 1	_	250	mW	
	SOT323	note 1	_	200	mW	
	SOT490	notes 1 and 2	_	250	mW	
	SOT883	notes 2 and 3	_	250	mW	
	SOT416	note 1	_	150	mW	
T _{stg}	storage temperature		-65	+150	°C	
T _j	junction temperature		_	150	°C	
T _{amb}	operating ambient temperature		-65	+150	°C	

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μm copper strip line.

PDTC143T series

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT490	notes 1 and 2	500	K/W
	SOT883	notes 2 and 3	500	K/W
	SOT416	note 1	833	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

CHARACTERISTICS

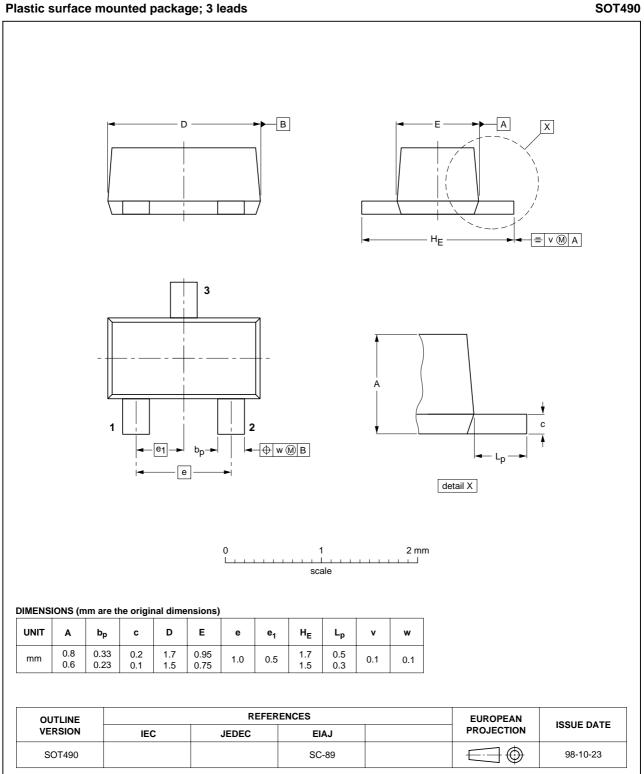
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT	
I _{CBO}	collector-base cut-off current	$V_{CB} = 50 \text{ V}; \text{ I}_{\text{E}} = 0 \text{ A}$	-	-	100	nA	
I _{CEO}	collector-emitter cut-off current	V _{CE} = 30 V; I _B = 0 A	-	-	1	μA	
		$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}; \text{ T}_{j} = 150 ^{\circ}\text{C}$	-	-	50	μA	
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	100	nA	
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 1 mA	200	-	-		
V _{CEsat}	collector-emitter saturation voltage	I _C = 5 mA; I _B = 0.25 mA	-	-	100	mV	
R1	input resistor		3.3	4.7	6.1	kΩ	
C _c	collector capacitance	$I_E = i_e = 0 \text{ A}; V_{CB} = 10 \text{ V};$ f = 1 MHz	-	_	2.5	pF	

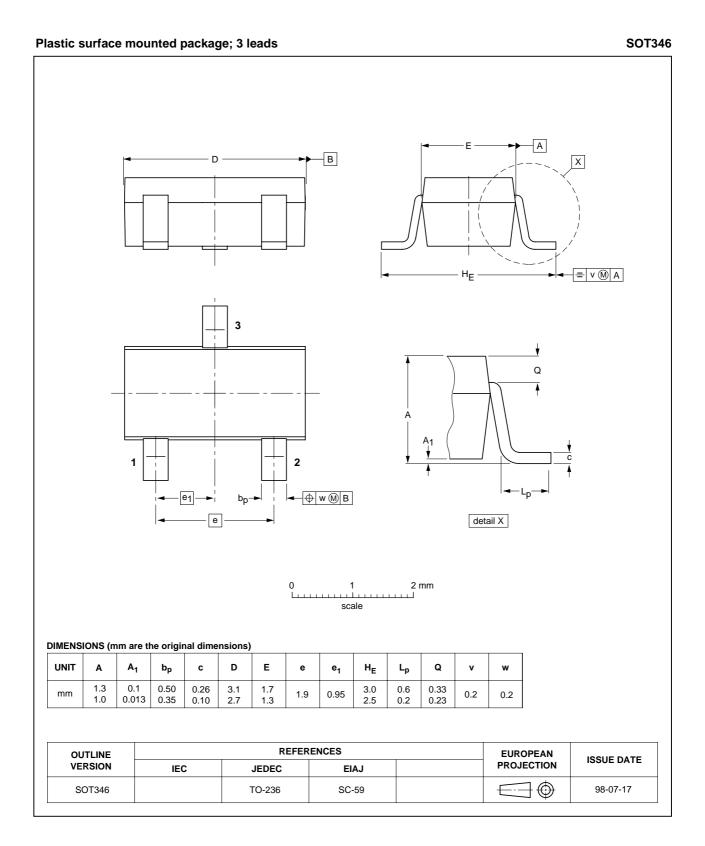
PDTC143T series

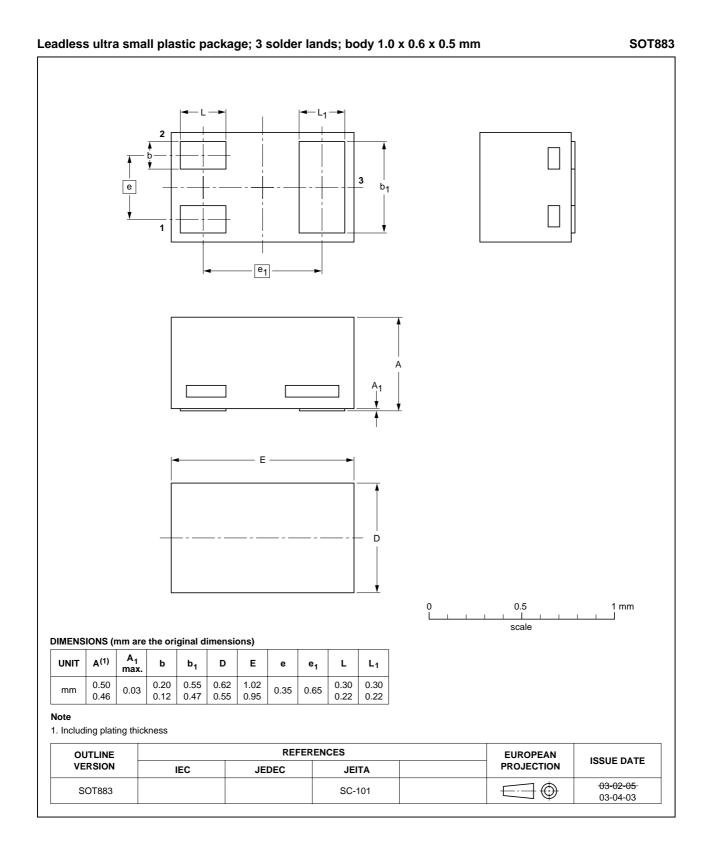
NPN resistor-equipped transistors; $R1 = 4.7 \text{ k}\Omega$, R2 = open

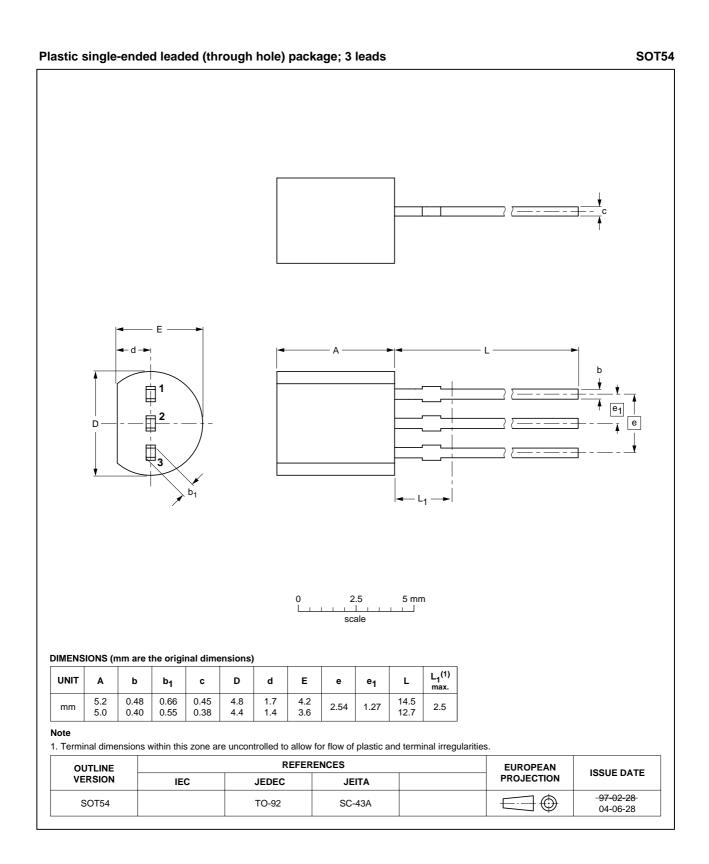
PACKAGE OUTLINES

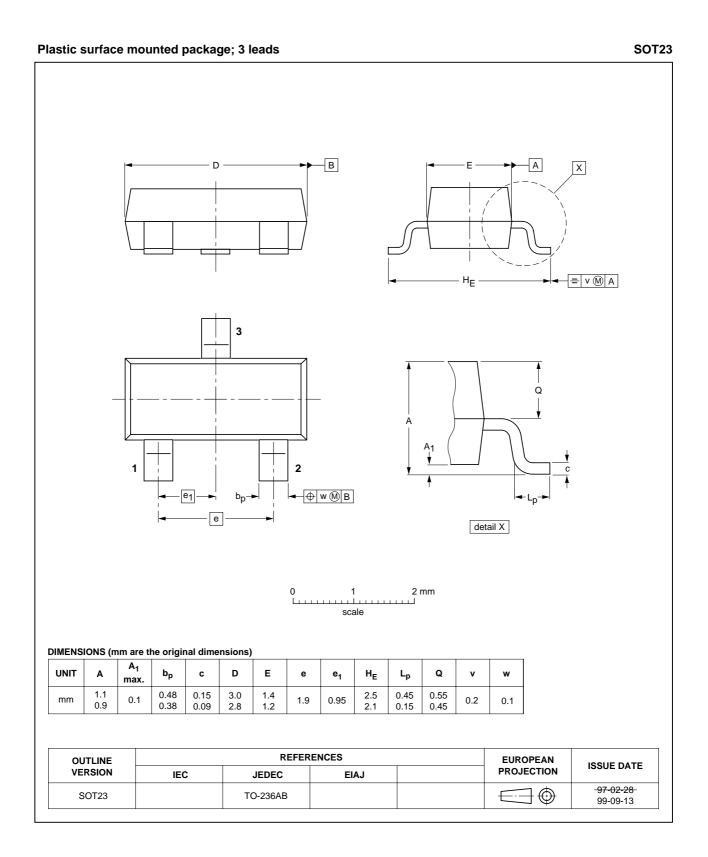


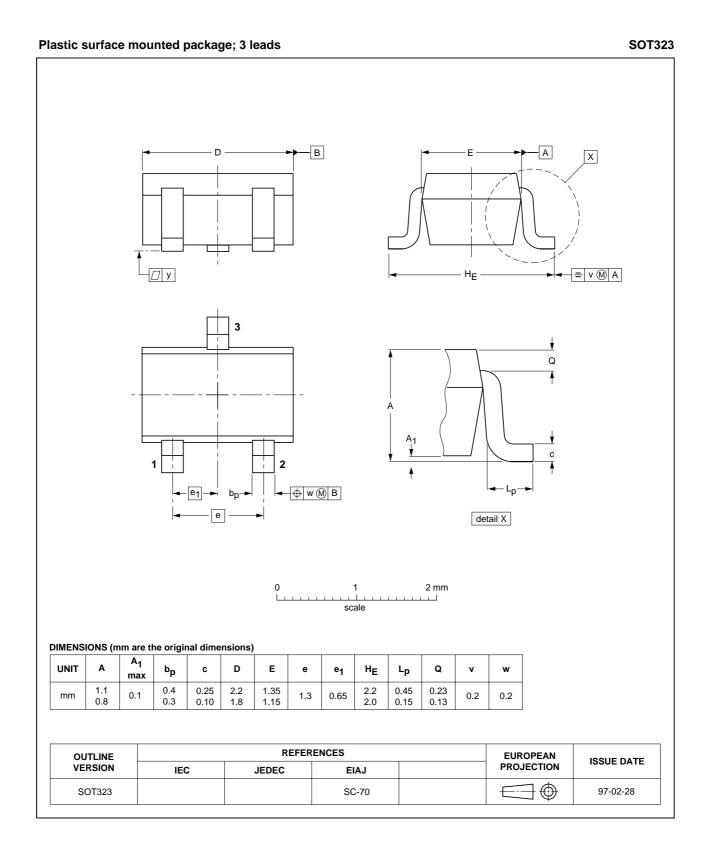
SOT490

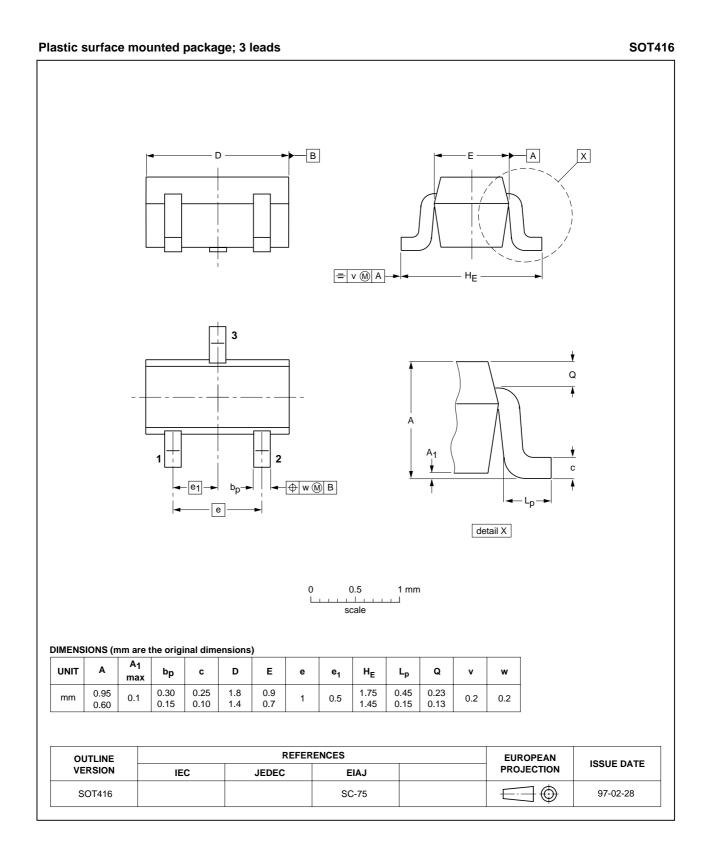












PDTC143T series

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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